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Vishay Siliconix

RoHS

COMPLIANT

HALOGEN FREE



PRODUCT SUMMARY				
V _{DS} (V)	-30			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0015			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V	0.0023			
Q _g typ. (nC)	170			
I _D (A) ^a	-227			
Configuration	Single			

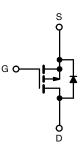
FEATURES

P-Channel 30 V (D-S) MOSFET

- · Leadership R_{DS(on)} minimizes power loss from conduction
- 100 % R_q and UIS tested
- Enhance power dissipation and lower R_{thJC}
- Material categorization: for definitions of please compliance see
- www.vishay.com/doc?99912

APPLICATIONS

- · Adapter and charger switch
- · Load switch
- Motor drive control
- Battery management



P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8S
Lead (Pb)-free and halogen-free	SiRS4301DP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-30	V	
Gate-source voltage		V _{GS} ± 20		V	
	T _C = 25 °C		-227		
	T _C = 70 °C		-182		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-53.7 ^{b, c}		
	T _A = 70 °C	1	-43.0 ^{b, c}	Α	
Pulsed drain current (t = 100 μs)		I _{DM}	-350	A	
Continuous source-drain diode current	T _C = 25 °C		-110		
	T _A = 25 °C	I _S	-6.1 ^{b, c}		
Single pulse avalanche current L = 0.1 mH		I _{AS}	-50		
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	125	mJ	
Maximum power dissipation	T _C = 25 °C		132		
	T _C = 70 °C		84	w	
	T _A = 25 °C	P _D	7.4 ^{b, c}	VV	
	T _A = 70 °C		4.7 ^{b, c}		
Operating junction and storage temperature	e range	T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) c		Ĭ	260	-0	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	t ≤ 10 s	R _{thJA}	13	17	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	0.73	0.95	0/10

Notes

a. T_C = 25 °C b. Surface mounted on 1" x 1" FR4 board

t = 10 sc.

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 45 °C/W e.

f.

S23-0168-Rev. C, 27-Mar-2023

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•				
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = -10 mA	-	-30	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	5.6	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-	-2.3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
7		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current	I _{DSS}	V_{DS} = -30 V, V_{GS} = 0 V, T_{J} = 55 °C	-	-	10	μA	
		V _{GS} = -10 V, I _D = -20 A	-	0.0012	0.0015	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	0.0018	0.0023		
Forward transconductance ^a	g _{fs}	V _{DS} = -15 V, I _D = -20 A	-	125	-	S	
Dynamic ^b			I	1	1		
Input capacitance	C _{iss}		-	19 750	-	pF	
Output capacitance	C _{oss}	V _{DS} = -15 V, V _{GS} = 0 V, f = 1 MHz	-	2070	-		
Reverse transfer capacitance	C _{rss}		-	1175	-		
		V _{DS} = -10 V, V _{GS} = -10 V, I _D = -20 A	-	365	548	nC	
Total gate charge	Qg	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	170	255		
Gate-source charge	Q _{gs}		-	64	-		
Gate-drain charge	Q _{gd}		-	55	-		
Output charge	Q _{oss}	$V_{DS} = -15 V, V_{GS} = 0 V$	-	43	-		
Gate resistance	R _q	f = 1 MHz	0.5	2.4	4.8	Ω	
Turn-on delay time	t _{d(on)}	V _{DD} = -15 V, R _L = 1.5 Ω, I _D ≅ -10 A,	-	22	44	-	
Rise time	t _r		-	28	56		
Turn-off delay time	t _{d(off)}	$V_{GEN} = -10 \text{ V}, \text{ R}_g = 1 \Omega$	-	210	420	_	
Fall time	t _f		-	90	180		
Turn-on delay time	t _{d(on)}		-	80	160	ns	
Rise time	t _r	V_{DD} = -15 V, R_L = 1.5 Ω , $I_D \cong$ -10 A,	-	160	320	-	
Turn-off delay time	t _{d(off)}	$V_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	210	420		
Fall time	t _f		-	140	280	_	
Drain-Source Body Diode Characterist	ics		•		1	•	
Continuous source-drain diode current	I _S	T _C = 25 °C -		-	110		
Pulse diode forward current	I _{SM}	-	-	-	350	A	
Body diode voltage	V _{SD}	I _S = -10 A, V _{GS} = 0 V	-	0.75	1.2	V	
Body diode reverse recovery time	t _{rr}		-	48	96	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -10 A, di/dt = 100 A/μs,	-	51	102	nC	
Reverse recovery fall time	t _a	$T_J = 25 \text{ °C}$	-	23	-	ns	
Reverse recovery rise time	t _b		_	25	_		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

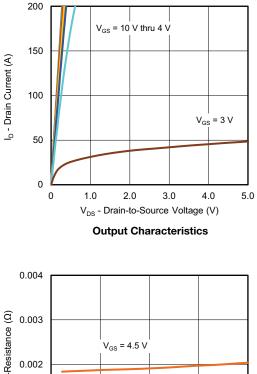
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

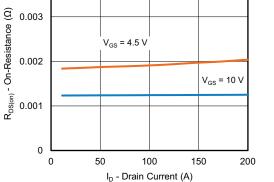
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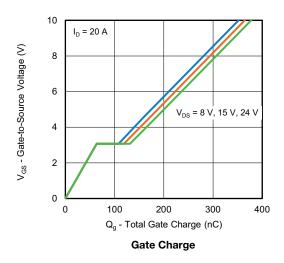
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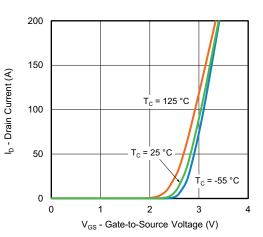
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



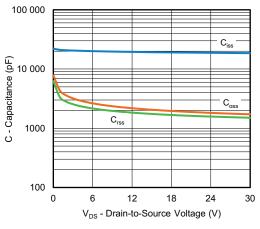


On-Resistance vs. Drain Current and Gate Voltage

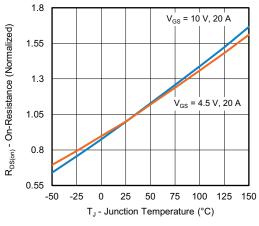




Transfer Characteristics



Capacitance



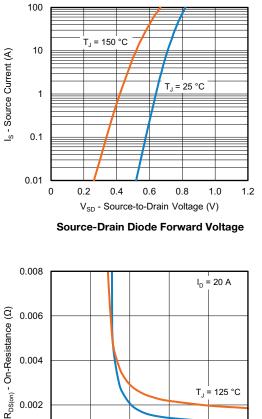
On-Resistance vs. Junction Temperature

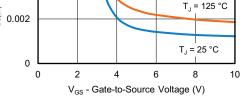
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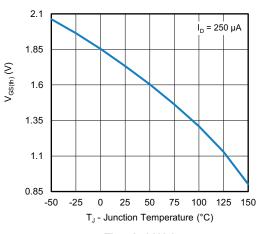
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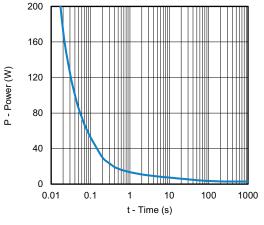




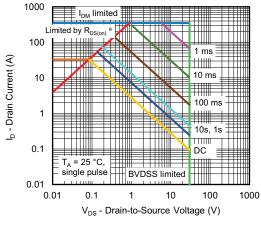
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

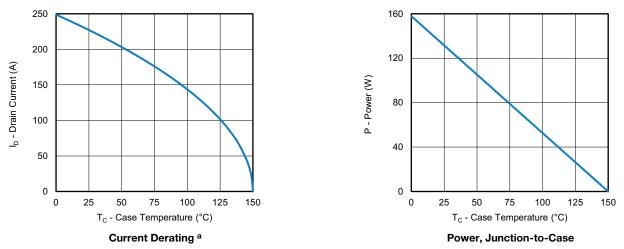
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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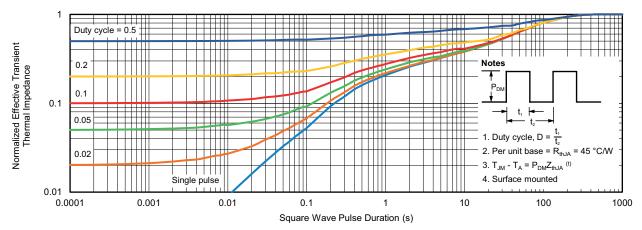


a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

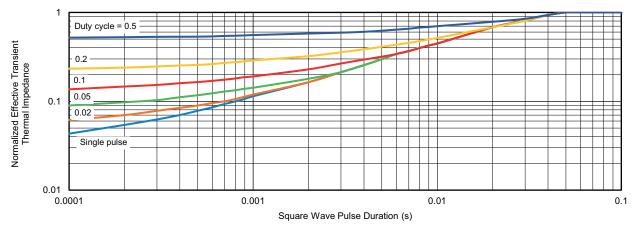


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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